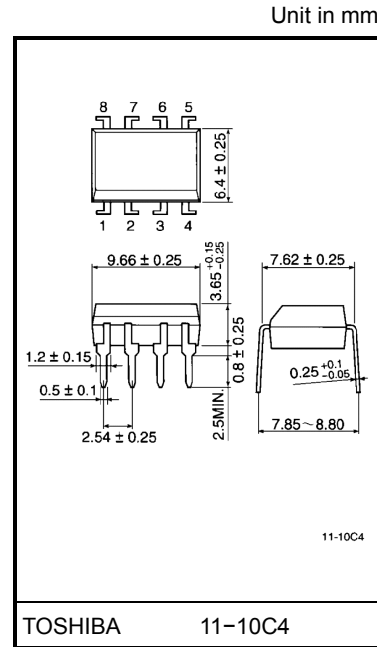


# 6N138, 6N139

Current Loop Driver.  
 Low Input Current Line Receiver.  
 CMOS Logic Interface.

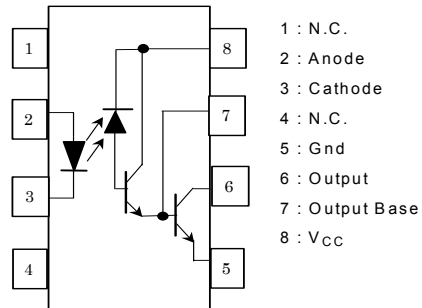
The TOSHIBA 6N138 and 6N139 consists of a GaAlAs infrared emitting diode coupled with a split-Darlington output configuration. A high speed GaAlAs Ired manufactured with an unique LPE junction, has the virtue of fast rise and fall time at low drive current.

- Isolation voltage: 2500Vrms (min.)
- Current transfer ratio
  - : 6N138 - 300% (min.) (IF=1.6mA)
  - : 6N139 - 400% (min.) (IF=0.5mA)
- Switching time: 6N138 - tPHL=10µs (max.)
  - tPLH=35µs (max.)
  - 6N139 - tPHL=1µs (max.)
  - tPLH=7µs (max.)
- UL recognized: UL1577, file no. E67349

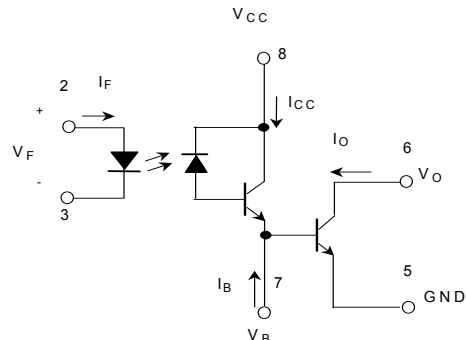


Weight: 0.54 g

## Pin Configuration (top view)



## Schematic



## Maximum Ratings (\*) (Ta = 0°C to + 70°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current (Note 1)	$I_F$	20	mA
	Pulse forward current	$I_{FP}^{(*)}$	40	mA
	Total pulse forward current	$I_{FP}^{(**)}$	1	A
	Reverse voltage	$V_R$	5	V
	Diode power dissipation (Note 2)	$P_D$	35	mW
Detector	Output current (Note 3)	$I_O$	60	mA
	Emitter-base reverse voltage	$V_{EB}$	0.5	V
	Supply voltage	$V_{CC}^{(*)}$	-0.5 to 18	V
	Output voltage	$V_O^{(*)}$	-0.5 to 18	V
	Output power dissipation (Note 4)	$P_O$	100	mW
Operating temperature range		$T_{opr}$	0 to 70	°C
Storage temperature range		$T_{stg}$	-55 to 125	°C
Lead solder temperature (10s) <sup>(*)</sup>		$T_{sol}$	260	°C
Isolation voltage (1min., R.H.≤ 60%)		$BV_S^{(**)}$	2500	$V_{rms}$
			3540	$V_{dc}$

(\*) JEDEC registered data

(\*\*) Not registered JEDEC

(\*1) 50% duty cycle, 1ms pulse width

(\*2) Pulse width 1μs, 300pps

(\*3) 6N138... -0.5 to 7V

(\*4) 1.6mm below seating plane

**Electrical Characteristics**

**Over Recommended Temperature (Ta = 0°C to 70°C, unless otherwise noted)**

Characteristic		Symbol	Test Condition	Min.	(*5)Typ.	Max.	Unit
Current transfer ratio (Note 5, 6)	6N139	CTR(*)	I <sub>F</sub> =0.5mA, V <sub>O</sub> =0.4V V <sub>CC</sub> =4.5V	400	800	—	%
	6N138		I <sub>F</sub> =1.6mA, V <sub>O</sub> =0.4V V <sub>CC</sub> =4.5V	500	900	—	
Logic low output voltage (Note 6)	6N139	V <sub>OL</sub>	I <sub>F</sub> =1.6mA, I <sub>O</sub> =6.4mA V <sub>CC</sub> =4.5V	—	0.1	0.4	V
			I <sub>F</sub> =5mA, I <sub>O</sub> =15mA V <sub>CC</sub> =4.5V	—	0.1	0.4	
	I <sub>F</sub> =12mA, I <sub>O</sub> =24mA V <sub>CC</sub> =4.5V		—	0.2	0.4		
	6N138		I <sub>F</sub> =1.6mA, I <sub>O</sub> =4.8mA V <sub>CC</sub> =4.5V	—	0.1	0.4	
Logic high output current (Note 6)	6N139	I <sub>OH</sub> (*)	I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =18V	—	0.05	100	μA
	6N138		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =7V	—	0.05	250	
Logic low supply current (Note 6)	I <sub>CCL</sub>	I <sub>F</sub> =1.6mA, V <sub>O</sub> =Open V <sub>CC</sub> =5V	—	0.2	—	mA	
Logic high supply current (Note 6)	I <sub>CCH</sub>	I <sub>F</sub> =0mA, V <sub>O</sub> =Open, V <sub>CC</sub> =5V	—	10	—	nA	
Input forward voltage	V <sub>F</sub> (*)	I <sub>F</sub> =1.6mA, Ta=25°C	—	1.65	1.7	V	
Input reverse breakdown voltage	BV <sub>R</sub> (*)	I <sub>R</sub> =10μA, Ta=25°C	5	—	—	V	
Temperature coefficient of forward voltage	ΔV <sub>F</sub> / ΔTa	I <sub>F</sub> =1.6mA	—	-1.9	—	mV / °C	
Input capacitance	C <sub>IN</sub>	f=1MHz, V <sub>F</sub> =0	—	60	—	pF	
Resistance (input-output)	R <sub>I-O</sub>	V <sub>I-O</sub> =500V R.H.≤ 60% (Note 7),	—	10 <sup>12</sup>	—	Ω	
Capacitance (input-output)	C <sub>I-O</sub>	f=1MHz (Note 7)	—	0.6	—	pF	

(\*\*) JEDEC registered data.

(\*5) All typicals at Ta=25°C and V<sub>CC</sub>=5V, unless otherwise noted.

## Switching Specifications (Ta=25°C, VCC=5V, unless otherwise specified)

Characteristic		Symbol	Test Circuit	Test Condition	Min.	Typ.	Max.	Unit
Propagation delay time to logic low at output (Note 6, 8)	6N139	$t_{pHL}^{(*)}$	1	$I_F=0.5mA, R_L=4.7k\Omega$	—	5	25	$\mu s$
				$I_F=12mA, R_L=270\Omega$	—	0.2	1	
	6N138			$I_F=1.6mA, R_L=2.2k\Omega$	—	1	10	
Propagation delay time to logic high at output (Note 6, 8)	6N139	$t_{pLH}^{(*)}$	1	$I_F=0.5mA, R_L=4.7k\Omega$	—	5	60	$\mu s$
				$I_F=12mA, R_L=270\Omega$	—	1	7	
	6N138			$I_F=1.6mA, R_L=2.2k\Omega$	—	4	35	
Common mode transient immunity at logic high level output (Note 9)		$CM_H$	2	$I_F=0mA, R_L=2.2k\Omega$ $V_{CM}=400V_{p-p}$	—	500	—	V / $\mu s$
Common mode transient immunity at logic low level output (Note 9)		$CM_L$	2	$I_F=1.6mA$ $R_L=2.2k\Omega$ $V_{CM}=400V_{p-p}$	—	-500	—	V / $\mu s$

(\*)JEDEC registered data.

(Note 1): Derate linearly above 50°C free-air temperature at a rate of 0.4mA / °C

(Note 2): Derate linearly above 50°C free-air temperature at a rate of 0.7mW / °C

(Note 3): Derate linearly above 25°C free-air temperature at a rate of 0.7mA / °C

(Note 4): Derate linearly above 25°C free-air temperature at a rate of 2.0mW / °C

(Note 5): DC CURRENT TRANSFER RATIO is defined as the ratio of output collector current,  $I_O$ , to the forward LED input current,  $I_F$ , times 100%.

(Note 6): Pin 7 open.

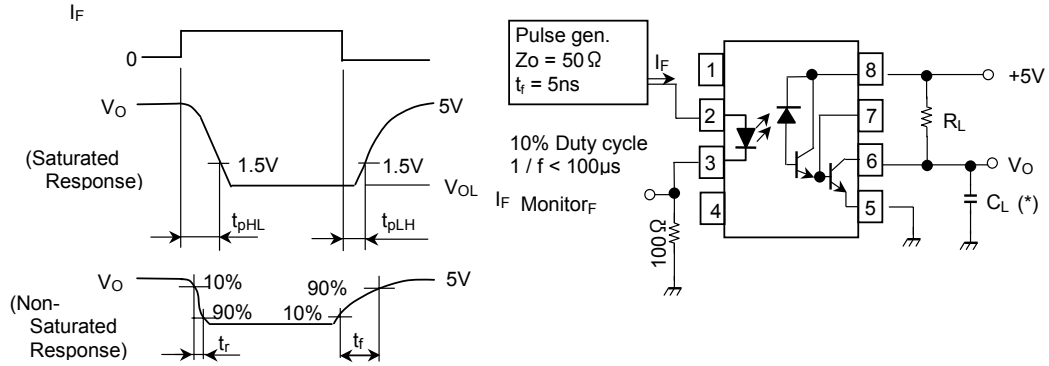
(Note 7): Device considered a two-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7 and 8 shorted together.

(Note 8): Use of a resistor between pin 5 and 7 will decrease gain and delay time.

(Note 9): Common mode transient immunity in logic high level is the maximum tolerable (positive)  $dv_{CM} / dt$  on the leading edge of the common mode pulse,  $V_{CM}$ , to assure that the output will remain in a logic high state (i.e.,  $V_O > 2.0V$ ).

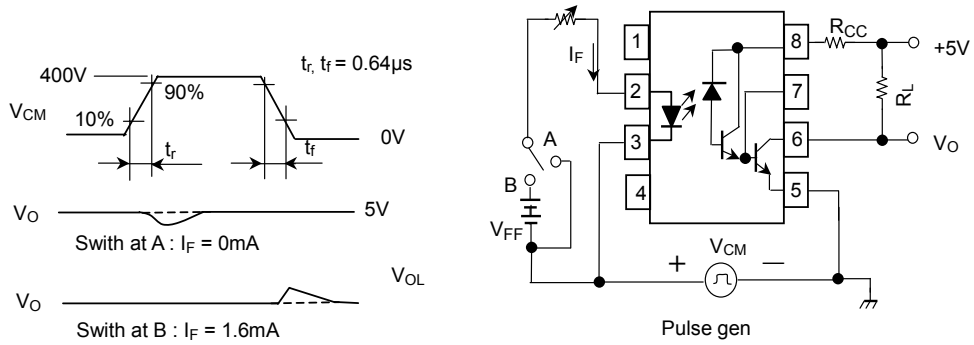
Common mode transient immunity in Logic Low level is the maximum tolerable (negative)  $dv_{CM} / dt$  on the trailing edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain in a logic low state (i.e.,  $V_O < 0.8V$ ).

**Test Circuit 1.**



(\*) $C_L$  is approximately 15pF which includes probe and stray wiring capacitance.

**Test Circuit 2.**



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000707EBC

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